产品规格承认书

SPECIFICATIONS

客户:	
CUSTOMER:	
产品名称: DESCRIPTION:	Multilayer chip Antenna
客户型号:	
CUSTOMER PART NO:	
产品型号:	
OUR MODEL NO:	PBX2012MA04
日期:	
DATE:	

Shenzhen Pengban Xingye Technology Co., Ltd Address: 605, Bullding 4, 1970 Sclence and Technology Park, Minzhl Community, Minzhi Street, Longhua District, Shenzhen

PBX2012MA04 Specification

Operating Temp.: -40°C~+85°C

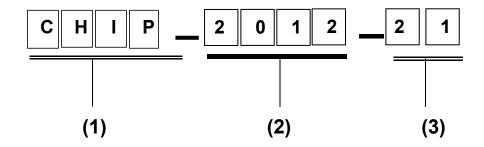
1. FEATURES:

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

2. APPLICATIONS:

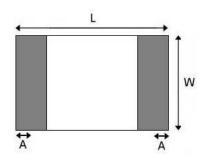
- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

3. PRODUCT IDENTIFICATION



- (1) Product type: Multilayer chip Antenna
- (2) External Dimensions (L×W) (mm): 2.0*1.2

4. SHAPE AND DIMENSIONS:





SHAPE AND DIMENSIONS

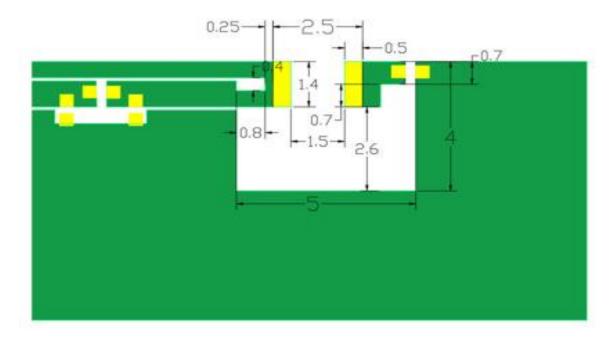
L	W	Н	A
2.0 ± 0.2	1.2 \pm 0.2	0.55 ± 0.1	0.4 ± 0.1

UNLESS OTHER SPEC X=± X.X=± ANGLES=±	FIED TOLERANCES ON: X.XX= HOLEDIA=±	深圳市朋伴兴业科技有限公司		[2]
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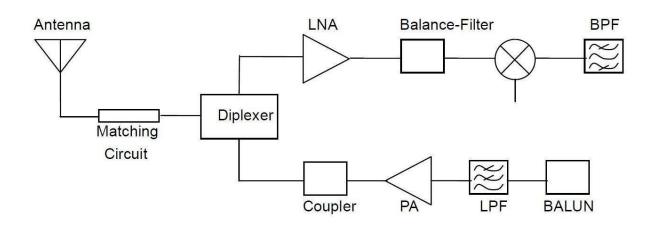
TERMINAL-CONFIGURATION



EVALUATION BOARD



APPLICATION GUIDE



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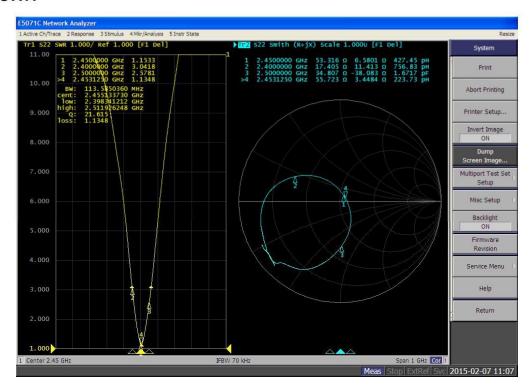
5. SPECIFICATIONS:

ITEM	SPECIFICATION
Frequency Band	$2400 \mathrm{MHz}{\sim}2483 \mathrm{MHz}$
VSWR	Less than 3
Polarization	Linear
*Peak Gain	2.48 dBi Typ.
*Peak Efficiency	72.6% Typ.
Impedance	50Ω Typ.

* Test condition: Test board size 98*65 mm Matching circuit: Pi matching circuit will be required

6. Electrical Characteristics:

VSWR

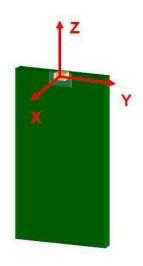


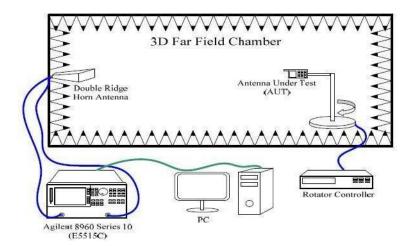
Mark	Frequency	VSWR
1	2400 MHz	3.04
2	2450 MHz	1.15
3	2500 MHz	2.57

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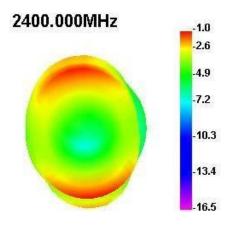
Radiation Pattern

The Gain pattern is measured in INPAQ's FAR-field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.

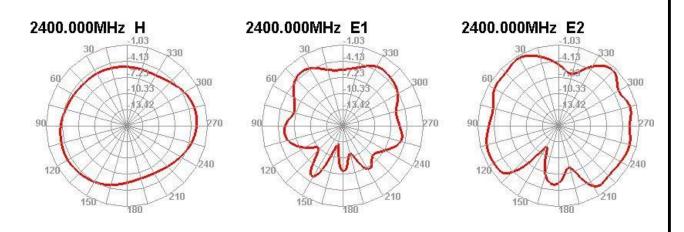




○ 3D Gain Pattern (2400 MHz)



O 2D Gain Pattern (2400 MHz)



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